

STL75N3LLZH5

N-channel 30 V, 0.0055 Ω 19 A PowerFLAT™ (5x6) STripFET™ V Power MOSFET

Preliminary data

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D
STL75N3LLZH5	30 V	<0.0061 Ω	19 A ⁽¹⁾

- 1. The value is rated according $R_{thj-pcb}$
- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses
- Built in G-S Zener diodes

Application

Switching applications

Description

The STL75N3LLZH5 is an N-channel STripFET[™]V Power MOSFET which has been designed to achieve very low on-state resistance providing also one of the best-in-class figure of merit (FOM). Vertication of the second sec

Figure 1. Internal schematic diagram

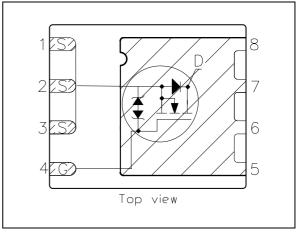


Table 1. Device summary

Order code Marking		Package	Packaging	
STL75N3LLZH5	STL75N3LLZH5 75N3LLZH5		Tape and reel	

Doc ID 17661 Rev 1

1/9

This is preliminary information on a new product now in development or undergoing evaluation. Details are subject to change without notice.

www.st.com

1 Electrical ratings

Table 2.	Absolute	maximum	ratings
	Aboulute	maximum	radingo

Symbol	Parameter	Value	Unit	
V_{DS}	Drain-source voltage ($V_{GS} = 0$)	30	V	
V _{GS}	Gate-source voltage	± 20	V	
I _D ⁽¹⁾	Drain current (continuous) at $T_C = 25 \ ^{\circ}C$	75	Α	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	47	Α	
I _D ⁽²⁾	Drain current (continuous) at T _C = 25 °C	19	Α	
I _D ⁽²⁾	Drain current (continuous) at T _C =100°C	11.8	Α	
I _{DM} ⁽³⁾	Drain current (pulsed)	76	Α	
P _{TOT} ⁽¹⁾	Total dissipation at $T_{C} = 25^{\circ}C$	60	W	
P _{TOT} ⁽²⁾	Total dissipation at $T_{C} = 25^{\circ}C$	4	W	
	Derating factor	0.03	W/°C	
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C	

1. The value is rated according ${\sf R}_{thj\text{-}c}$.

2. The value is rated according $\mathsf{R}_{thj\text{-pcb.}}$

3. Pulse width limited by safe operating area.

Table 3.	Thermal	resistance
----------	---------	------------

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case (Drain) (steady state)	2.08	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-ambient	31.3	°C/W

1. When mounted on FR-4 board of 1inch², 2oz Cu, t < 10 sec



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified).

	On/on states					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = max rating, V _{DS} = max rating @125 °C			1 10	μΑ μΑ
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			±100	nA
V _{GS(th)}	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	1			V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 9.5 A V _{GS} = 4.5 V, I _D = 9.5 A		0.0055 0.0066	0.0061 0.0078	Ω Ω

Table 4. On/off states

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25 V, f=1 MHz, V _{GS} =0	-	1510 287 40	-	pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} =15 V, I _D = 19 A V _{GS} =4.5 V <i>Figure 3</i>	-	11.8 4 6	-	nC nC nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} =15 V, I_D = 9.5 A, R _G =4.7 Ω , V_{GS} =10 V <i>Figure 2</i>	-	9.2 11 55 20	-	ns ns ns ns



Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current		-		19	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		76	А
$V_{SD}^{(2)}$	Forward on voltage	I _{SD} = 19 A, V _{GS} =0	-		1.1	V
t _{rr}	Reverse recovery time	I _{SD} = 19 A,		24		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs,	-	17		nC
I _{RRM}	Reverse recovery current	V _{DD} =25 V, Tj=150 °C		1.4		Α

 Table 7.
 Source drain diode

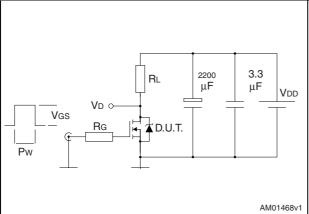
1. Pulse width limited by safe operating area.

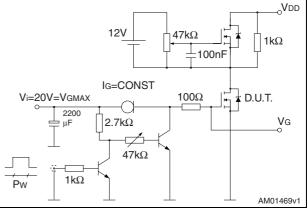
2. Pulsed: pulse duration= 300 $\mu s,$ duty cycle 1.5%.



3 Test circuits

Figure 2. Switching times test circuit for resistive load





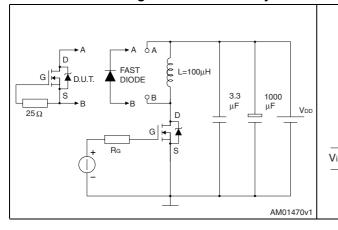
Gate charge test circuit

Figure 3.

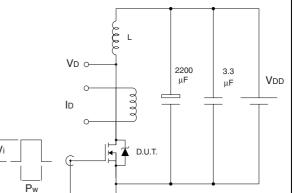
Figure 5.

circuit

Figure 4. Test circuit for inductive load switching and diode recovery times

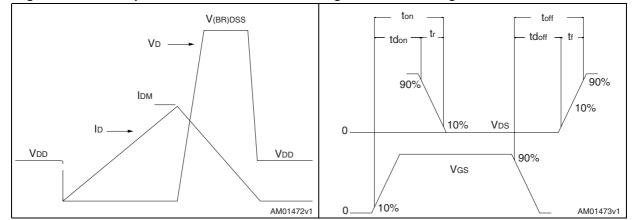






Unclamped inductive load test

Figure 7. Switching time waveform





Doc ID 17661 Rev 1

AM01471v1

4 Package mechanical data

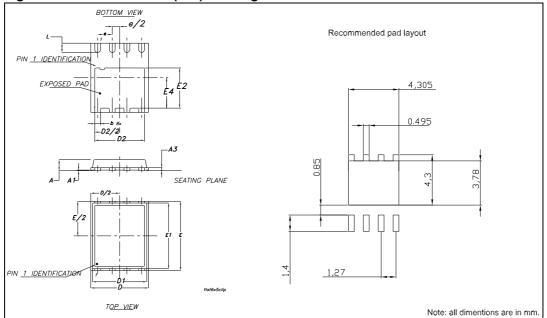
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



Table 0.	FOWELLAI	(3x0) 11100	manical uala	uala			
Dim		mm.			inch.		
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.80	0.83	0.93	0.031	0.32	0.036	
A1		0.02	0.05		0.0007	0.0019	
A3		0.20			0.007		
b	0.35	0.40	0.47	0.013	0.015	0.018	
D		5.00			0.196		
D1		4.75			0.187		
D2	4.15	4.20	4.25	0.163	0.165	0.167	
E		6.00			0.236		
E1		5.75			0.226		
E2	3.43	3.48	3.53	0.135	0.137	0.139	
E4	2.58	2.63	2.68		0.103	0.105	
е		1.27			0.050		
L	0.70	0.80	0.90	0.027	0.031	0.035	

Table 8. Power FLAT[™] (5x6) mechanical data





5 Revision history

Table 9.Document revision history

Date	Revision	Changes
22-Jun-2010	1	First release.



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2010 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



Doc ID 17661 Rev 1

9/9